

Field-Effect Control of Graphene–Fullerene Thermoelectric Nanodevices

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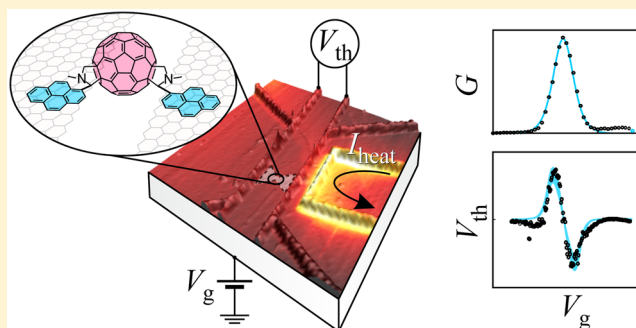
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Supporting Information

ABSTRACT: Although it was demonstrated that discrete molecular levels determine the sign and magnitude of the thermoelectric effect in single-molecule junctions, full electrostatic control of these levels has not been achieved to date. Here, we show that graphene nanogaps combined with gold microheaters serve as a testbed for studying single-molecule thermoelectricity. Reduced screening of the gate electric field compared to conventional metal electrodes allows control of the position of the dominant transport orbital by hundreds of meV. We find that the power factor of graphene–fullerene junctions can be tuned over several orders of magnitude to a value close to the theoretical limit of an isolated Breit–Wigner resonance. Furthermore, our data suggest that the power factor of an isolated level is only given by the tunnel coupling to the leads and temperature. These results open up new avenues for exploring thermoelectricity and charge transport in individual molecules and highlight the importance of level alignment and coupling to the electrodes for optimum energy conversion in organic thermoelectric materials.

KEYWORDS: electroburning, graphene, single molecule, thermoelectrics, molecular thermopower, molecular conductance



The thermopower or Seebeck coefficient S of a material or nanoscale device is defined as $S = -\Delta V / \Delta T$, where ΔV is the voltage difference generated between the two ends of the junction when a temperature difference ΔT is established between them. In addition to the goal of maximizing S , there is a great demand for materials with a high power factor S^2G , which is a measure for the amount of energy that can be generated from a temperature difference, and high thermoelectric efficiency, which is expressed in terms of a dimensionless figure of merit $ZT = S^2GT / \kappa$, where T is the average temperature, G is the electrical conductance and κ is the sum of the electronic and phononic contribution to the thermal conductance. In conventional thermoelectric materials S , G and κ are typically mutually contra-indicated, such that high S is accompanied by low G and high G by high κ .¹ In some nanostructured materials these properties can be decoupled.² Therefore, the thermoelectric properties of nanostructures like carbon nanotubes,³ quantum dot devices,^{4–6} and single-molecule junctions^{7–14} have been studied extensively. In the past few years it has been demonstrated both experimentally and theoretically that, at the molecular scale, S can be controlled by the chemical composition,¹⁰ the position of intramolecular energy levels relative to the work function of

metallic electrodes,¹² by systematically increasing the single-molecule lengths within a family of molecules^{9,11} and by tuning the interaction between two neighboring molecules.⁸ Despite these advances, single-molecule experiments have only yielded values of S ranging from 1 to 50 $\mu\text{V K}^{-1}$.^{7,15} The key challenge in achieving high Seebeck coefficients in molecular junctions lies in controlling the energetic position and “steepness” of the transport resonances.

We use graphene-based lateral single-molecule devices—where a molecule sits in the gap between two graphene leads—to study the gate-dependent thermoelectric properties of C_{60} molecules. The two-dimensional nature of graphene electrodes leads to a reduced screening of the gate electric field compared to bulky metal electrodes,¹⁶ enabling us to shift the orbital energy levels of the molecule with respect to the electrochemical potential of the graphene leads using a backgate. We exploit this field-effect control to map the thermovoltage across entire molecular transport resonances.

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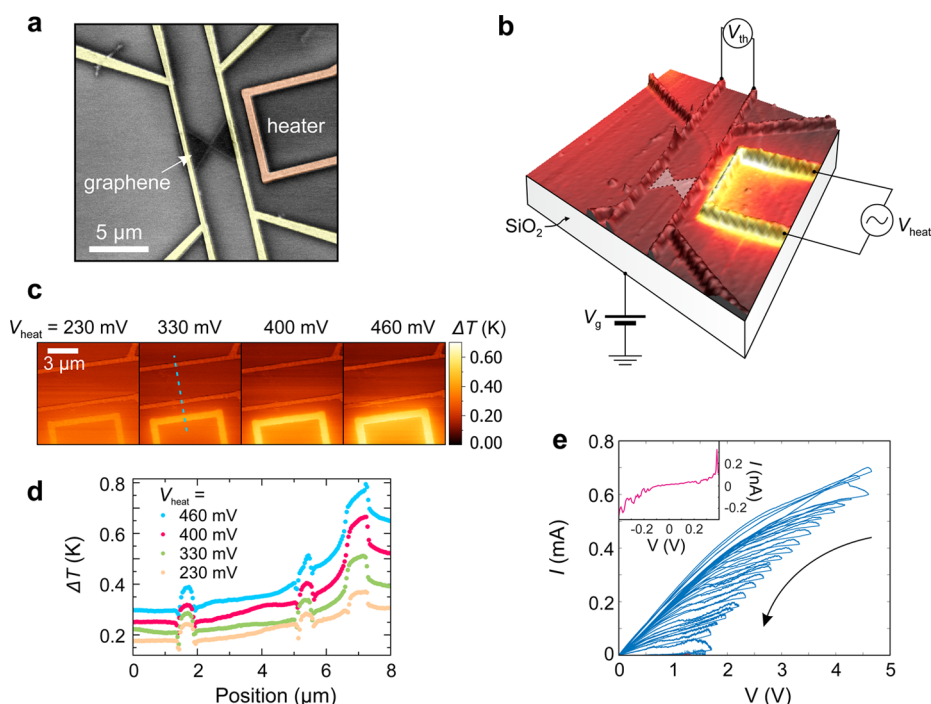


Figure 1. Device geometry and scanning thermal microscopy. (a) False-color scanning electron microscopy image of the device. (b) Atomic force microscopy height profile overlaid with scanning thermal microscopy signal and sketch of the device geometry for a typical thermovoltage measurement. (c) Scanning thermal microscopy images recorded at different constant voltages V_{heat} applied to the microheater. (d) Line profiles along the device extracted from the maps shown in c (see blue dotted line). (e) I - V_{sd} traces recorded during feedback-controlled electroburning. Inset: I - V_{sd} trace after completed electroburning.

Experimental Section. Our devices consist of CVD graphene etched into a bow-tie shape on-top of gold contacts (see [Methods](#) for fabrication details). Each gold lead has four contacts for precise four-terminal resistance measurements, which allows us to measure the temperature difference across the graphene junction (see [Figure S1](#)). A gold microheater is fabricated $1\ \mu\text{m}$ away from the junction (see [Figure 1a](#)). By passing a current through the microheater we create a temperature gradient across the junction.^{3,17,18} We quantify this temperature gradient by cross-checking several methods to eliminate potential systematic errors. These are (i) measuring the resistance of the left and right gold contacts, (ii) using COMSOL finite-element simulations, and (iii) using scanning thermal microscopy (SThM) measurements. Using method (i) we measure a temperature difference between the hot (closer to the microheater) and cold (further from the microheater) contact as a function of heater power $\Delta T/P_{\text{heater}} = 58 \pm 11\ \text{K W}^{-1}$ at $T_0 = 77\ \text{K}$ (see Chapters 1 and 8, [Supporting Information](#) for details of the calibration method and an estimation of the total uncertainty, respectively). This is in close agreement with the finite-element simulations (method (ii)) which predict $\Delta T/P_{\text{heater}} = 50\ \text{K W}^{-1}$ and a constant temperature gradient $\nabla T/P_{\text{heater}} = 14\ \text{K }\mu\text{m}^{-1}\ \text{W}^{-1}$ across the length of the graphene junction (see [Figure S5](#)). [Figure 1b](#) shows a temperature map overlaid onto a height profile that were simultaneously recorded using a SThM (method (iii)). From the temperature maps recorded for different heater powers in [Figure 1c](#) and [d](#) we extract a power-dependent temperature gradient $\nabla T/P_{\text{heater}} = 18\ \text{K }\mu\text{m}^{-1}\ \text{W}^{-1}$ and a temperature difference $\Delta T/P_{\text{heater}} = 63 \pm 10\ \text{K W}^{-1}$ between the two gold contacts under ambient conditions and $\Delta T/P_{\text{heater}} = 71 \pm 11\ \text{K W}^{-1}$ for $77\ \text{K}$ and vacuum (see Chapter 3,

[Supporting Information](#)). For all the analysis presented below we will use the value extracted using method (i).

We use feedback-controlled electroburning^{19–22} (see [Figure 1e](#)) to first form graphene nanogaps suitable for characterization of single molecules²³ in which we subsequently couple C_{60} molecules functionalized with pyrene anchor groups (see [Figure 2a](#)). We have chosen this molecule since it is stable in air and has previously been successfully coupled to graphene electrodes²⁴ and because its thermoelectric properties have been studied using various other techniques, including STM based break junctions^{8,12} and electromigrated gold break junctions.⁷ After electroburning we characterize the graphene gaps by measuring the current I_{sd} as a function of gate and bias voltage (stability diagram) at $T_0 = 77\ \text{K}$ in vacuum. Empty devices, where there are no carbon islands or ribbons bridging the gap, are characterized by nonlinear $I_{\text{sd}} - V_{\text{sd}}$ curves and little or no gate modulation. After this first characterization step we warm up the device and deposit C_{60} molecules by immersing the sample in a $10\ \mu\text{M}$ chloroform solution containing the C_{60} bisadducts for 1 min followed by blow drying with nitrogen gas. We then measured the devices again at low temperature to look for signatures of molecules. In total we fabricated 1080 two-terminal devices on which we performed feedback controlled electroburning. Due to limitations of our setup, we were then only able to study 100 devices at low temperatures of which 16 devices showed signatures of molecule deposition: (1) a clear change from “empty” to Coulomb blockade after molecule deposition; (2) vibrational fingerprints in the excited state spectrum measured in the sequential tunneling regime.

Results and Discussion. We often observe multiple overlapping, nonclosing Coulomb diamonds which indicate the formation of molecular junctions where more than one

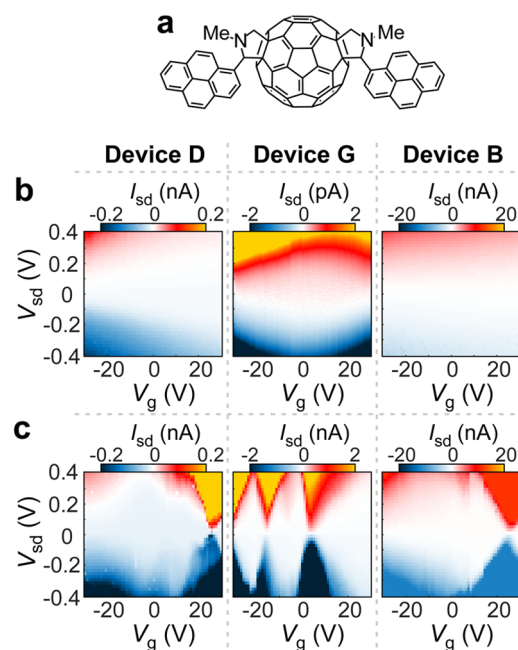


Figure 2. Electrical characterization of graphene–fullerene single-molecule thermoelectric nanodevices. (a) Chemical structure of the C₆₀ bisadducts functionalized with pyrene anchor groups. (b) Current map as a function of back gate and bias voltage before and (c) after molecule deposition recorded at $T_0 = 77$ K for devices D, G, and B, respectively.

molecule contribute to the electrical transport. In the following we discuss the data for three selected devices where the Coulomb diamonds close in the accessible back-gate region with addition energies >400 meV. We focus on these devices as their transport is most likely dominated by a single molecule. Moreover, the large addition energies enables us to study well-isolated energy levels that are expected to show the largest Seebeck coefficient. Chapter 5 of the Supporting Information includes the data of all measured devices.

Figure 2b shows the stability diagrams of devices B, D and G measured at 77 K before and after molecule deposition. In Figure 2b, before molecule deposition, the source–drain current shows only weak gate dependence, but in Figure 2c regions of Coulomb blockade can be observed after deposition. We attribute the sequential electron tunneling after molecule

deposition to the formation of a molecular junction.^{19,23,24} To further investigate the single electron transport, we studied several devices at low temperatures ($T < 5$ K). In a previous study we observed excited state lines in the sequential tunneling regime that correspond to $H_g(1)$ and $A_g(1)$ Raman active vibrational modes of C₆₀ as well as center-of-mass motion of the C₆₀ molecule with respect to the graphene electrodes.²⁴ In total, 7 of 16 devices showed similar evidence for vibrational excited states (see Table S2, Supporting Information). Four out of 16 devices changed permanently to a nonconducting state after cool down to <5 K, and no low-temperature data could be recorded. The visibility of vibrational excited states strongly depends on temperature, the tunnel coupling to the leads²⁵ and the Franck–Condon factors^{26,27} which can vary drastically between different molecular junctions and the charge transition investigated.^{24,28} Moreover, the density of states fluctuations in the graphene leads can lead to features inside the sequential tunneling regime, which do not run parallel to the edges of the Coulomb diamonds, which can obscure any vibrational fingerprint.²⁹

Next, we measure the gate dependent thermoelectric properties of the C₆₀–graphene junctions. We apply an AC voltage with modulation frequency f to the microheater and measure the thermovoltage V_{th} drop on the device at a frequency $2f$ for different back gate voltages V_g (see Figure 1b).¹⁷ We focus on the high-conductance gate region around the Coulomb peaks (see gate traces in Figure 3a) since the thermovoltage signal inside the Coulomb blocked region is smaller than the noise level of our measurement setup. Figure 3b shows the measured gate-dependent thermovoltage signal for Devices D, G, and B, recorded at $\Delta T = 45 \pm 9$ mK, $\Delta T = 100 \pm 20$ mK, and $\Delta T = 180 \pm 36$ mK, respectively. An increase of V_{th} followed by a sign change, further decrease, and subsequent increase toward zero can be observed. Similar results have been observed for seven other devices (see Chapter 5, Supporting Information). Using the applied temperature bias ΔT we find maximum Seebeck coefficients S_{max} ranging from 1.5 to $460 \mu\text{V K}^{-1}$ (see Table 1). On average, these values are more than 1 order of magnitude larger than the Seebeck coefficients found in STM break junction experiments of C₆₀ contacted with different metal electrodes.^{8,12} In the following we use a simple model for an isolated Breit–Wigner resonance to explain these results.

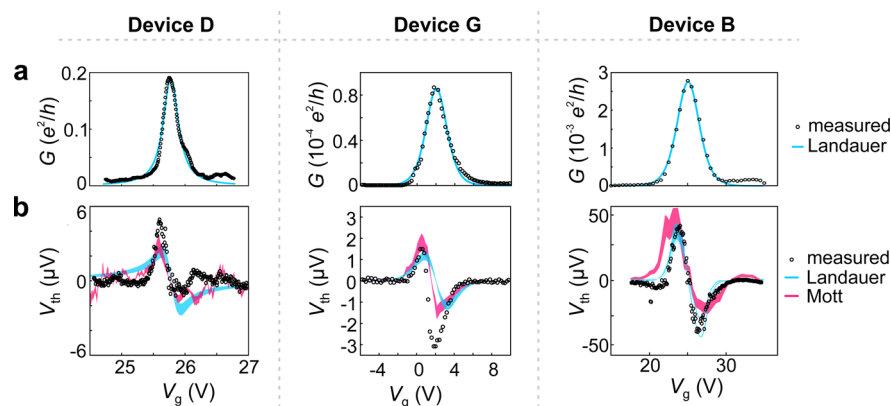


Figure 3. Thermoelectric measurements. (a) AC zero-bias conductance and (b) thermovoltage (measured with a temperature bias of $\Delta T = 45 \pm 9$ mK, $\Delta T = 100 \pm 20$ mK, and $\Delta T = 180 \pm 36$ mK, respectively) as a function of back gate voltage measured at $T_0 = 3.2$ K (Device D) and $T_0 = 77$ K (Devices G and B). The blue and pink curves show theoretical calculations using a Landauer-type approach and the Mott formula, respectively.

Table 1. Measurement Results for Each C₆₀ Device

device name	Γ (μeV)	χ	α (meV/V)	E_0 (meV)	S_{max} ($\mu\text{V/K}$)	G_{max} (e^2/h)	$(S^2G)_{\text{max}}$ (k_B^2/h)	T_0 (K)
B	88		9	221	220	0.003	0.01	77
C	1.3×10^3		10	188	140	0.08	0.08	77
D	2.7×10^3	15	13	335	27	0.2	0.14	3.2
E	16		6	53	238	0.006	0.02	11
F	1.7×10^2		11	84	460	0.01	0.11	77
G	2		9	12	30	10^{-4}	0.04	77
Q	2.4×10^4	1.2×10^4	62	564	1.5	2×10^{-4}	7×10^{-4}	77

In the linear temperature and bias regime the conductance G can be expressed in terms of the moments L_i of the transmission coefficient $P(E)$ as³⁰

$$G(V_g, T_0) = \frac{2e^2}{h} L_0 \quad (1)$$

with

$$L_i = \int_{-\infty}^{\infty} (E - E_F)^i P(E) dE \quad (2)$$

where we use the non-normalized probability distribution³¹

$$P(E) = -\mathcal{T}(E) \frac{\partial f(E)}{\partial E} \quad (3)$$

For a single, well-isolated molecular level we can assume a Breit–Wigner resonance to describe the transmission probability $\mathcal{T}(E)$:

$$\mathcal{T}(E) = \frac{\Gamma_L \Gamma_R}{(\Gamma_L/2 + \Gamma_R/2)^2 + [(e\alpha V_g - E_0) - E]^2} \quad (4)$$

where E_0 is the energy of the transport resonance, Γ_L and Γ_R are the tunnel couplings to the leads, and the lever arm $\alpha = \frac{dE}{dV_g}$ is determined by the capacitive coupling of the molecule to the gate, source, and drain electrodes.³² The derivative of the Fermi–Dirac distribution is

$$\frac{\partial f(E)}{\partial E} = \frac{1}{4kT_0} \cosh^{-2} \left(\frac{E}{2kT_0} \right) \quad (5)$$

In the limit where $\Gamma = \Gamma_L + \Gamma_R \gg k_B T_0$ eq 1 reduces to $G = \frac{2e^2}{h} \mathcal{T}(E)$, and the tunnel coupling to the two leads can be inferred from the height and width of the Coulomb peak. In the opposite limit where $\Gamma \ll k_B T_0$ the maximum conductance G_{max} is proportional to $\frac{\Gamma_L \Gamma_R}{\Gamma_L + \Gamma_R}$, while the width of the Coulomb peak is proportional to $k_B T_0$.

When a temperature bias ΔT is applied to a junction, the Fermi–Dirac distribution of the hot contact broadens compared to that of the cold contact. This gives rise to a thermal current I_{th} , which leads to a thermovoltage V_{th} when measured under open circuit conditions $I(\Delta T, V_{\text{th}}) = 0$. The ratio of the thermovoltage and the temperature drop is the Seebeck coefficient $S = -V_{\text{th}}/\Delta T$. Similar to the conductance, the Seebeck coefficient is given by a Landauer-type expression using eqs 2, 3, and 5:

$$S(V_g, T_0) = -\frac{1}{eT_0} \frac{L_1}{L_0} \quad (6)$$

If $\mathcal{T}(E)$ varies only slowly with E on the scale of $k_B T_0$, that is, $\Gamma \gg k_B T_0$, then S takes the well-known form of the Mott approximation³³

$$S = -\frac{\pi^2 k_B^2 T_0}{3e\alpha} \frac{1}{G} \frac{dG}{dV_g} \quad (7)$$

In Figure 3b we compare our experimental results to the calculated thermovoltages using the Mott approximation (eq 7) and the Landauer-type approach (eq 6), respectively, where the width of the curve indicates the error in estimating the temperature drop on the junction (see full error analysis in Chapter 8, Supporting Information). For both calculations the thermovoltage was corrected by a damping factor due to the input impedance of the voltage amplifier (see Chapter 8.4, Supporting Information).⁵ To compare the measured thermovoltage to that obtained from eqs 6 and 7 we assume that the temperature difference ΔT between the hot and the cold sides of the molecule is equal to the temperature difference measured between the two gold contacts. Since cooling lengths of up to 7 μm have been reported for graphene,³⁴ the assumption that hot electrons injected from the gold contacts into the graphene leads do not thermalize before they reach the junction area approximately 1.7 μm away from the gold contacts is justified. By assuming that no temperature drops on the graphene leads, we only estimate a lower bound of S . In addition, we neglect the effect of thermovoltages created in the strongly p-doped graphene leads whose Seebeck coefficient is on the order of 10 $\mu\text{V/K}$.¹⁷ However, this would result in a small, constant offset of the thermovoltage in the applied gate voltage regime far away from the Dirac point of our graphene,²² which we do not observe in our experiments.

For the calculation of the Seebeck coefficient using the Landauer-type approach (eq 6) we estimate $\mathcal{T}(E)$ by eq 4 and extract the tunnel coupling by fitting the gate-dependent conductance traces to eq 1 if $\Gamma \gg k_B T_0$. For those devices where $\Gamma \ll k_B T_0$, we estimate $\mathcal{T}(E)$ by fitting the conductance data with a thermally broadened conductance peak $G = G_{\text{max}} \cosh^{-2}[(\alpha V_g - E_0)/(2k_B T_0)]$ with $G_{\text{max}} = e^2/(\hbar 4k_B T) \Gamma_L \Gamma_R / (\Gamma_L + \Gamma_R)$,³⁵ where we fix $T_0 = 77$ K and find a lower bound for Γ by taking $\Gamma_L = \Gamma_R$ such that $\Gamma_{\text{lower}} = 4k_B T_0 \frac{2h}{\pi e^2} G_{\text{max}}$. Despite the fact that we can not uniquely determine Γ in this regime, there is still good agreement between the measured and the calculated thermovoltage curves. This is due to the relative insensitivity of S on the lifetime of the transport resonance when $\Gamma \ll k_B T_0$ (see Figure S22).

Finally, we use our experimental results to calculate the power factor S^2G for Devices D, G, and B (see Figure 4a and Chapter 5, Supporting Information for other devices). Significantly, we find that S^2G can be tuned by several orders of magnitude by electrical gating to maximum values of 0.01–

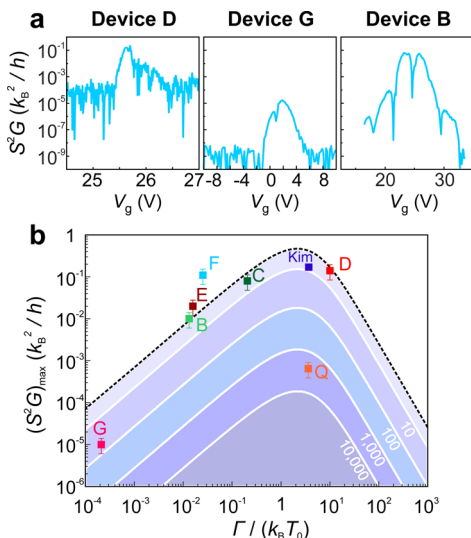


Figure 4. Maximum power factor. (a) Power factor as a function of back gate voltage measured at $T_0 = 3.2$ K (Device D) and $T_0 = 77$ K (Device G and B). (b) Maximum power factor as a function of tunnel coupling Γ for the devices investigated in this study and by Kim et al.⁷ The dashed black line ($\chi = 1$) and the white lines show theoretical curves calculated using eq 8 for different ratios between the fast and slow tunnel rates χ . The error bars of the data points are estimated by neglecting the error in G and using the relative error in determining ΔT (20%) to estimate the error for S . The total error of the power factor $PF = S^2G$ is propagated: $\Delta PF = \sqrt{\left(\frac{\partial PF}{\partial S}\Delta S\right)^2} = 2SG\Delta S = 2S^2G\frac{\Delta S}{S}$

$0.14k_B^2/h$ (see Table 1). These values are 1–2 orders of magnitude larger than values found in C_{60} junctions without sufficient electric field control^{8,12,14} and comparable to the value found for C_{60} measured using gold break junctions with an electrical back gate.⁷

To evaluate the thermoelectric performance of different devices, we plot the maximum power factor $(S^2G)_{\max}$ on a log–log scale as a function of the temperature-normalized tunnel rate $\Gamma/k_B T_0$. We compare these values to the theoretical maximum calculated using

$$S^2G = \frac{2}{h} \frac{L_1^2}{T_0^2 L_0} \quad (8)$$

and eqs 1–6. In addition to the theoretical maximum power factor for devices with symmetric tunnel coupling (black dashed line), we plot the theoretical values for $(S^2G)_{\max}$ for different ratios between the fast and slow tunnel rates $\chi = \Gamma_{\text{fast}}/\Gamma_{\text{slow}}$ (solid white lines), where $\Gamma_{\text{fast}} = \max(\Gamma_L, \Gamma_R)$ and $\Gamma_{\text{slow}} = \min(\Gamma_L, \Gamma_R)$. For devices in the regime where $\Gamma \ll k_B T_0$ we use the lower bound Γ_{lower} as described above. Since the maximum power factor in this regime is independent of the asymmetry between the fast and slow tunnel coupling (see Figure S21), the measured power factor for these devices are expected to fall on the black dashed line corresponding to $\chi = 1$. For the device where $\Gamma \ll k_B T_0$, G, B, E, F, and C, we observe an increase of $(S^2G)_{\max}$ with increasing Γ_{lower} due to the power factor being proportional to $G_{\max}$. As Γ approaches $k_B T_0$ the power factor reaches a maximum $S^2G \approx \frac{1}{2.2} \times k_B^2/h$ for $\Gamma \approx 2.2k_B T_0$. Devices D and Q were measured close to this maximum, as was the C_{60} molecule measured by Kim et al. at 100 K denoted “Kim” in Figure 4b.⁷ While devices D and “Kim” have a power factor close to the theoretical limit, for device Q $(S^2G)_{\max}$ is

several orders of magnitude lower as a result of the asymmetric coupling $\chi \approx 10^4$ in this device. For $\Gamma \gg k_B T_0$ the maximum power factor is expected to decrease with increasing Γ as the lifetime broadening reduces the Seebeck coefficient. No devices were measured in this regime.

On the basis of our finding, we conclude that there are three goals for achieving high thermoelectric performance in molecular nanodevices. First, the molecular energy levels need to align closely with the Fermi level of the electrodes since the Seebeck coefficient is maximum for E close to the center of the transmission resonance. Second, the tunnel coupling needs to be such that the lifetime of the transmission resonance is comparable to $k_B T_0$ at the operating temperature. Third, the tunnel couplings to the left and right electrode need to be equal to achieve a maximum power factor.

To summarize, we have fabricated thermoelectric nanodevices in which fullerene molecules are anchored between graphene source and drain leads. We demonstrate that by applying a thermal bias across the junction we can measure a gate-dependent thermoelectricity. Our results show that, by carefully tuning the transmission of a molecular junction toward sharp isolated resonance features, high power factors can be achieved approaching the theoretical limit of a thermally and lifetime broadened Coulomb peak. These results are relevant for the development of organic thermoelectric materials, and our approach could also be applied to test hypotheses about the thermoelectric properties of molecules exhibiting quantum interference effects³⁰ and spin caloritronics.³⁶

Methods. Device Fabrication. Our devices are fabricated from single-layer CVD-grown graphene, which we transfer onto a Si/300 nm SiO_2 wafer with prepatterned 10 nm Cr/70 nm Au contacts and microheater. We pattern the graphene into a bow-tie shape (see Figure 1a) using standard electron beam lithography and O_2 plasma etching. The channel length L of the devices and the width W of the narrowest part of the constriction are 3.5 μm and 200 nm, respectively. To narrow down the constriction or form a nanogap, we use a feedback-controlled electroburning technique in air²² using an ADWin Gold II card with a 30 kHz sampling rate. Electroburning cycles are repeated until a critical resistance of 500 M Ω is reached.

Scanning Thermal Microscopy Temperature Measurements. This method uses a temperature sensitive calibrated microfabricated probe with an apex of a few tens of nm that is brought in direct solid–solid contact with the sample. The SThM response V_t is a linear function of the local sample temperature T_s . For a flat sample surface and constant tip–surface thermal resistance (this is the case when the tip is in contact with the same material, e.g., SiO_2) it allows the direct mapping of a 2D distribution of the temperature increase in the vicinity of the microheater ΔT_s , as well as obtaining an absolute value of the sample temperature increase due to microheater actuation using the following two quantitative methods: (1) In the null-method the probe apex temperature T_a is varied, as the probe is brought repeatedly into contact with the sample. The value at which no change in the probe response V_t occurs corresponds to $T_s = T_a$, which provides an absolute temperature measurement with an error of about 15% (see Chapter 2 and 3 Supporting Information for details). (2) In the SThM addition method the sample is heated both by the microheater as well as by the calibrated raise in the temperature of the sample stage, allowing us to perform measurements under vacuum and variable sample temperatures (see Chapters 2 and 3 Supporting Information for more details). These measurements show good

correlation of the experimentally measured temperature maps with the finite-elements models. SThM measurements under ambient conditions were performed using a commercial SPM (Bruker MultiMode with Nanoscope E controller) and a custom-built SThM modified AC Wheatstone bridge. A resistive SThM probe (Kelvin Nanotechnology, KNT-SThM-01a, 0.3 N/m spring constant, <100 nm tip radius) served as one of the bridge resistors allowing precise monitoring of the probe AC electrical resistance at 91 kHz frequency via lock-in detection of the signal (SRS Instruments, SR830) as explained elsewhere.³⁷ Surface temperature maps were obtained at varying DC current to the probe that generated variable Joule heating of the probe tip. Several driving currents were used ranging from 0.10 to 0.40 mA leading to excess probe temperatures up to 34 K. The probe temperature–electrical resistance relation was determined via a calibrated Peltier hot/cold plate (Torrey Pines Scientific, Echo Therm IC20) using a ratiometric approach (Agilent 34401A).³⁷ The double-scan technique was used with different probe driving currents in order to obtain quantitative measurements of the surrounding and of the heater temperature.³⁸ Laser illumination on the probe (on the order of 5 K) added to the Joule heating and was accounted for via measurement of the corresponding probe resistance change. SThM thermal mapping was performed with a set-force below 15 nN during imaging to protect the tip and the sample from damage.

Electric and Thermoelectric Transport Measurements. Graphene nanostructures were characterized in an Oxford Instruments Triton 200 dilution refrigerator with 20 mK base temperature. All measurements on C₆₀ junctions were performed in a liquid nitrogen dip-stick setup. Electrical DC transport measurements were performed using low-noise DC electronics (Delft box). To measure the thermoelectric properties of nanostructures, we used the 2*f* method.³ To this end an AC heater voltage $V_{\text{heat}}(f)$ with frequency *f* was applied to the microheater using a HP33120a arbitrary waveform generator. The thermovoltage was measured with a SR560 voltage preamplifier and a SRS830 lock-in amplifier at a frequency 2*f* (see Chapter 7, [Supporting Information](#) for more details).

■ ASSOCIATED CONTENT

■ Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: [10.1021/acs.nanolett.7b03736](https://doi.org/10.1021/acs.nanolett.7b03736).

Calibration of the heater: resistance method; calibration of the heater: scanning thermal microscopy; calibration of the heater: vacuum and variable temperature scanning thermal microscopy; calibration of the heater: COMSOL simulations; supporting thermoelectric data: C₆₀ junctions; maximum power factor; details on thermovoltage measurements; error analysis ([PDF](#))

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Notes

The authors declare no competing financial interest.

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